

ZHCS756

SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

- V_R = 60V
- I_F = 750mA
- I_R = 50μA

Description and Applications

- DC DC Converters
- Mobile Telecomms
- PCMIA

Features and Benefits

- High current capability (I_F = 750mA)
- Low V_F
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)

SOT23

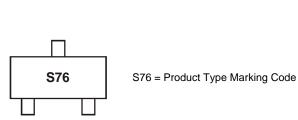
Top View

Ordering Information (Note 1)

Device		Packaging	Shipping
ZHCS756TA		SOT23	3000/Tape & Reel
	000000		

Notes: 1. For Packaging Details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characte	Symbol	Value	Units	
Continuous Reverse Voltage	V _R	60	V	
Continuous Forward Current	lF	750	mA	
Forward Voltage @ I _F = 750mA	VF	610	mV	
Average Peak Forward Current; D.C. = 50%		I _{FAV}	1500	mA
Non Repetitive Forward Current	t ≤ 100μs		12	А
	t ≤ 10ms	IFSM	5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation, $T_A = 25^{\circ}C$	PD	500	mW
Junction Temperature	TJ	125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

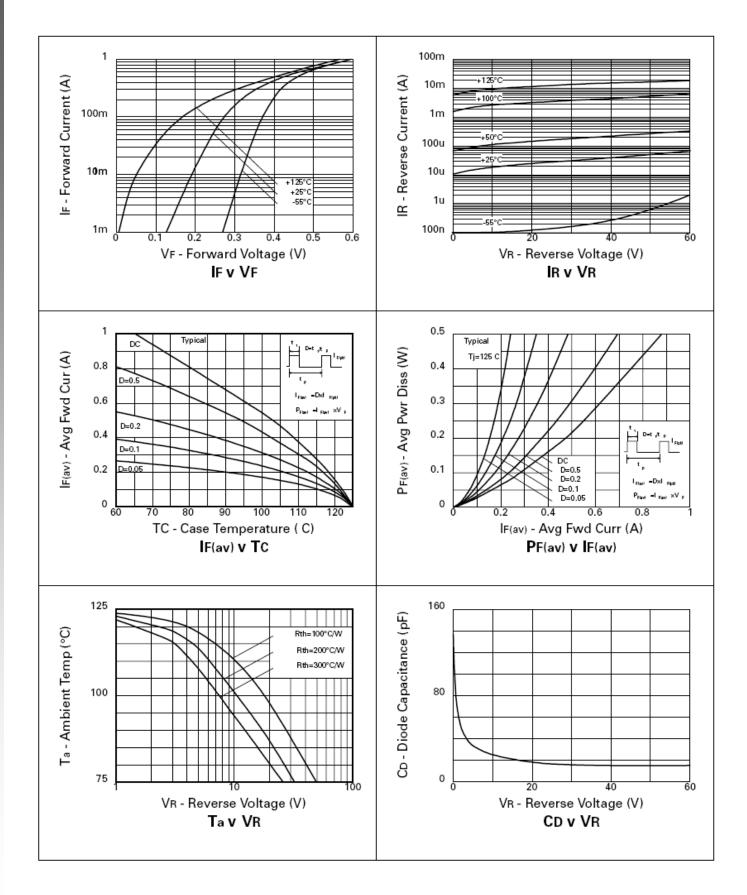
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	60	80	-	V	I _R = 300μA
	VF	-	250	290	mV	I _F = 50mA
		-	285	330		I _F = 100mA
		-	350	410		I _F = 250mA
Forward Voltage (Note 2)		-	440	500		I _F = 500mA
		-	520	610		I _F = 750mA
		-	600	700		$I_F = 1A$
		-	760	900		I _F = 1.5A
Reverse Current	I _R	-	50	100	μA	V _R = 45V
Diode Capacitance	CD	-	17	-	pF	f = 1MHz, V _R = 25V
Reverse Recovery Time	trr	-	12	-	ns	Switched from $I_F = 500$ mA to $I_R = 500$ mA Measured @ $I_R = 50$ mA

Notes: 2. Measured under pulsed conditions. Pulse width = 300μ S. Duty cycle $\leq 2\%$.



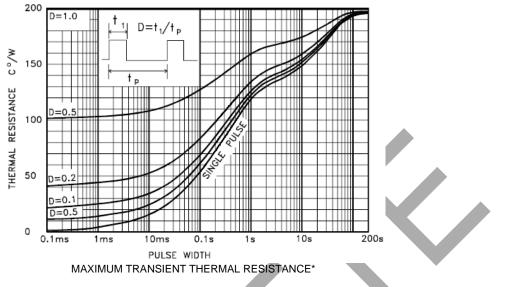
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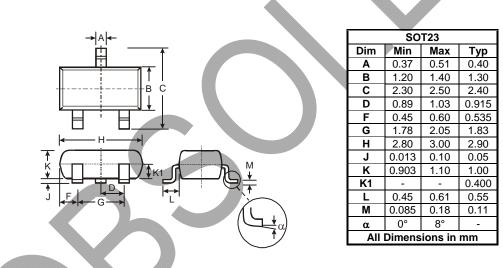
PART OBSOLETE - USE SBR160S23

ZHCS756

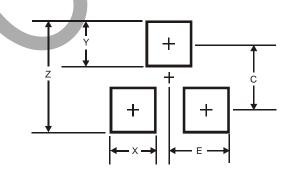


* Reference above figure, devices were mounted on a 15mmx15mm ceramic substrate.

Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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